



Specifications

Mounting Style:	PCB-type
Permissible Temp. With / Without load:	-20 deg C to +85 Deg. C
Permissible Temp. For Soldering:	270 Deg. C for 5 seconds max.
Panel Thickness(Max):	N.A.
Material:	Polyamide
Insulation Resistance:	1000 M Ohms min.
H. V. Break Down:	2 KVAC for 1 Minute
Current Carrying Parts:	Brass, Tin Plated
Contact Resistance (Initial):	10 m Ohms max.
Cap Design:	N.A.
Fuse Link Size:	5 x 20 mm
Rated Current / Voltage:	6.3 Amp, 250 VAC
Terminals:	Solder-type



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